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History

Version	Release Date	Descript
1.0	8/29/2006	1. First release.
1.1	8/31/2006	1. Add contents page.
1.2	9/6/2006	1. Add electrical characteristics descript.
1.3	9/7/2006	1. Modify feature descript error. 2. Redefine pin name. 3. Modify system clock descript. 4. Modify electrical characteristics. 5. Add history page. 6. Add Bonding PAD map.
1.4	1/16/2007	1. Add Application circuit.
1.5	01/25/2007	1. Remove current DAC function.
1.6	02/26/2007	1. Remove current DAC output pin.
1.7	03/01/2007	1. Add ROSC application circuit.
1.8	03/06/2007	1. Modify application error. 2. Add Regulator section.



1. INTRODUCTION

The SNC749 is a simply chip base on new DSP technology. SNC749 provide simply and easy control functions for system manufactory. SNC749 also is a high performance voice IC. That is built-in 64K word high speed ROM, and by different model to built-in 64K word, 448K words low speed ROM, the maximum program size is full ROM size include high-speed and low-speed ROM.

The SNC749 have three timer, one real time clock and one watchdog timer and built-in a hi-performance software synthesizer to provide lot of voice effects, such as hi-decompression engine to support from 1.5Kbps ~ 32Kbps compression rate for speech and music, multi-channel voice synthesizer to provide 12-channel wave table melody.

2. FEATURES

- ◆ Power supply: 2.4V ~ 3.6V (for 2 batteries application)
3.6V ~ 5.1V (for 3 batteries application)
- ◆ Built-in a new 16-bit DSP core with 16 MIPS CPU performance
- ◆ Software-based voice/melody processing
- ◆ Rich Function Instruction Set
- ◆ System Clock
 - 16MHz crystal or R-C type oscillator for system clock
- ◆ I/O Ports:
 - 24 I/O pins (P0.0~P0.15, P1.0~P1.7)
 - P0.15 with IR carrier signal
- ◆ RAM size: 4K*16 bits
- ◆ ROM size: 512KW
 - High performance program ROM: 64K*16 bits
 - Low speed ROM: 448KW
- ◆ Maximum program size: Full ROM Size
- ◆ 3 Timer, 1 RTC, 1 WDT
 - Timer With Individual pre-scalar and auto-reload function
 - RTC with 0.25/0.5/1 sec period
 - Watchdog Timer
- ◆ 9 Interrupt Sources
 - 4 for Internal Timer (timer0, 1, 2 and RTC)
 - 4 for External (P0.0~P0.3)
 - 1 for DA (Push Pull DAC)
- ◆ Two voice channels / 12 melody channels
- ◆ Three 8-bit timer with auto-reload function
- ◆ Built in a 10-bit Push-Pull DAC direct drive circuit
- ◆ Internal regulator provided



- ◆ Low Voltage Reset
- ◆ Low Voltage Detect
- ◆ Sampling Rate: 8KHz ~16KHz
- ◆ Built-in software voice synthesizer (LRC5 : 1.5K, 1.72K, 2K, 2.4K, 3K, 4K DRC : 5K, 6K SN : 8K MSADPCM : 35K PCM : 80K AUDIO32_16K : 16K, 20K, 24K, 28K, 32K)
- ◆ Built-in software melody synthesizer includes the dual-tone melody and 12-channel wave-table melody.

3. PIN ASSIGNMENT

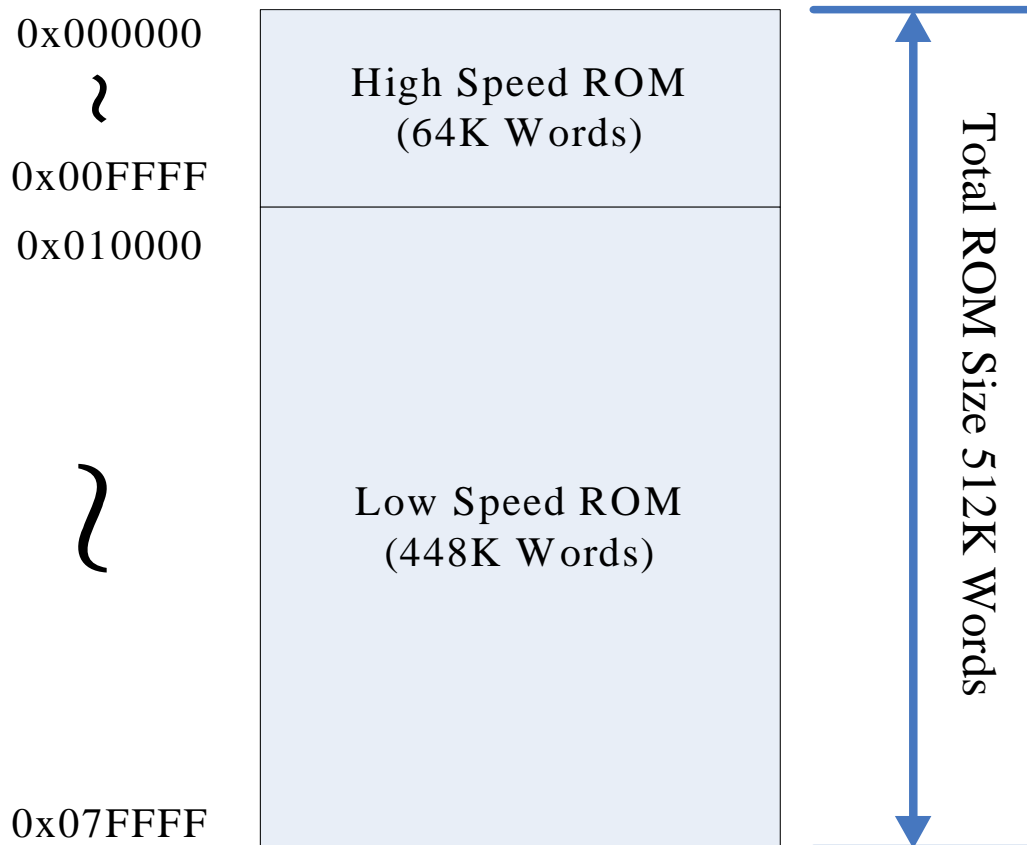
Pin No.	Symbol	I/O	Descriptions
1	Test	I	Test Pin for testing using
2	VSSIO2	I	Negative power supply
3	CVSS	I	Negative power supply for core circuit
4	RST	I	Chip reset
5	CKSEL	I	Crystal/RC-type oscillator select for high speed clock
6	VDDIO2	I	Positive power supply
7	CVDD	I	Positive power supply for core circuit
8	REGOUT	O	Regulator voltage output
9	VSSA	I	Negative power supply
10	XIN	I	High speed clock crystal input
11	XOUT	O	High speed clock crystal output
12	LXIN	I	Low speed clock crystal input
13	LXOUT	O	Low speed clock crystal output
14	VDDA	I	Positive power supply
15	NC	-	-
16	P0.0	I/O	I/O Port 0
17	P0.1	I/O	I/O Port 0
18	P0.2	I/O	I/O Port 0
19	P0.3	I/O	I/O Port 0
20	VSSIO0	I	Negative power supply
21	P0.4	I/O	I/O Port 0
22	P0.5	I/O	I/O Port 0
23	P0.6	I/O	I/O Port 0
24	P0.7	I/O	I/O Port 0
25	VDDIO0	I	Positive power supply
26	P0.8	I/O	I/O Port 0
27	P0.9	I/O	I/O Port 0
28	P0.10	I/O	I/O Port 0
29	P0.11	I/O	I/O Port 0
30	VSSIO0	I	Negative power supply



Pin No.	Symbol	I/O	Descriptions
31	P0.12	I/O	I/O Port 0
32	P0.13	I/O	I/O Port 0
33	P0.14	I/O	I/O Port 0
34	P0.15	I/O	I/O Port 0
35	P1.0	I/O	I/O Port 1
36	P1.1	I/O	I/O Port 1
37	P1.2	I/O	I/O Port 1
38	P1.3	I/O	I/O Port 1
39	VDDIO1	I	Positive power supply
40	P1.4	I/O	I/O Port 1
41	P1.5	I/O	I/O Port 1
42	P1.6	I/O	I/O Port 1
43	P1.7	I/O	I/O Port 1
44	VSSIO1	I	Negative power supply
45	VSSPP	I	Negative power supply
46	BP0	O	Push Pull output 1
47	VDDPP	I	Positive power supply
48	BN0	O	Push Pull output 2
49	VSSPP	I	Negative power supply

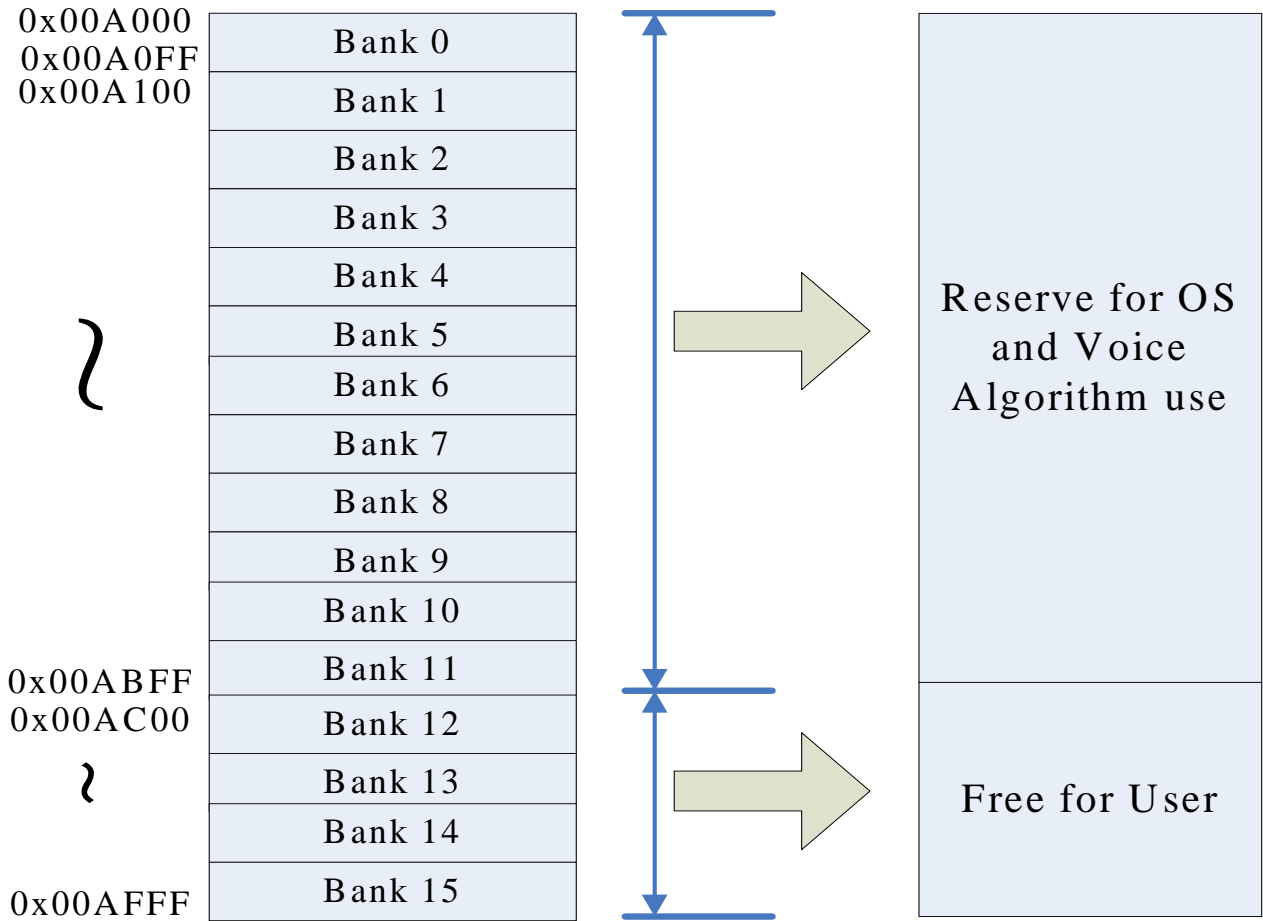
4. ROM TABLE

The total ROM size is 512K words. It split two parts including high speed and low speed ROM area, but user also can program all area. In high speed ROM had a small OS to control all function flow. We recommend user put you program in high speed ROM and put data in low speed ROM to get high performance.



5. RAM TABLE

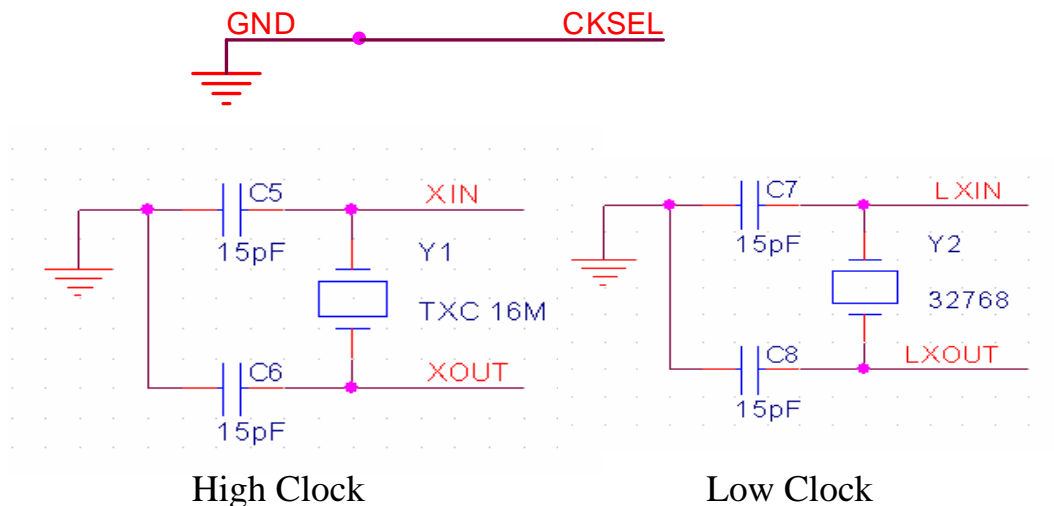
Total RAM size is 4K words, and each one bank is 256 words. The RAM size 0~3K words is for algorithm using and last 1K words is for user using.



6. System Clock

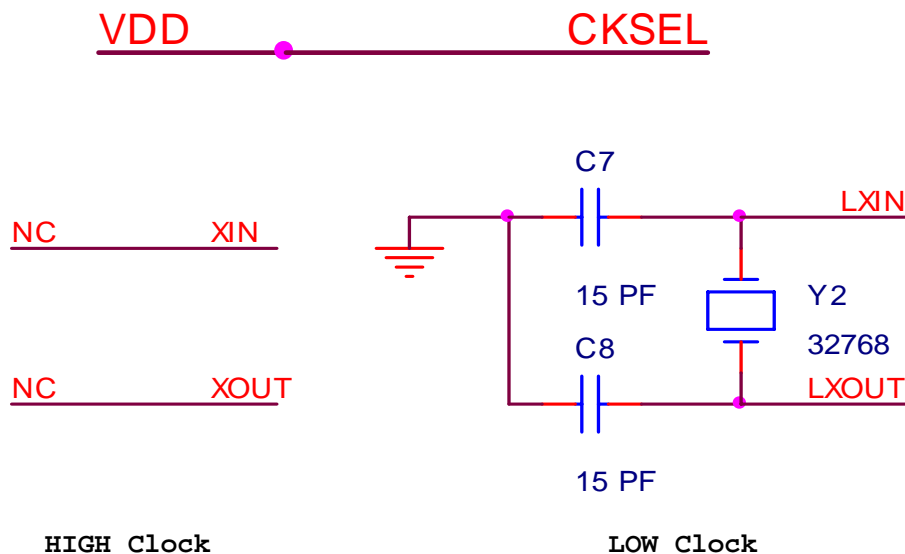
The system clock had dual source high clock and low clock input, user can selected from 16Mhz crystal or ROOSC for high clock and 32768 crystal for low clock. In Normal mode, user can select high clock source from 16Mhz crystal or ROOSC, In Slow mode, user must select 32768 crystal to input system clock.

6.1 Crystal Input



6.2 ROOSC Input

User uses ROOSC mode to make High clock. The internal clock is reference clock from 32768 X'tal to fine tune to 16MHz. So, when ROOSC mode is select, the 32768 X'tal must provide reference clock to system.

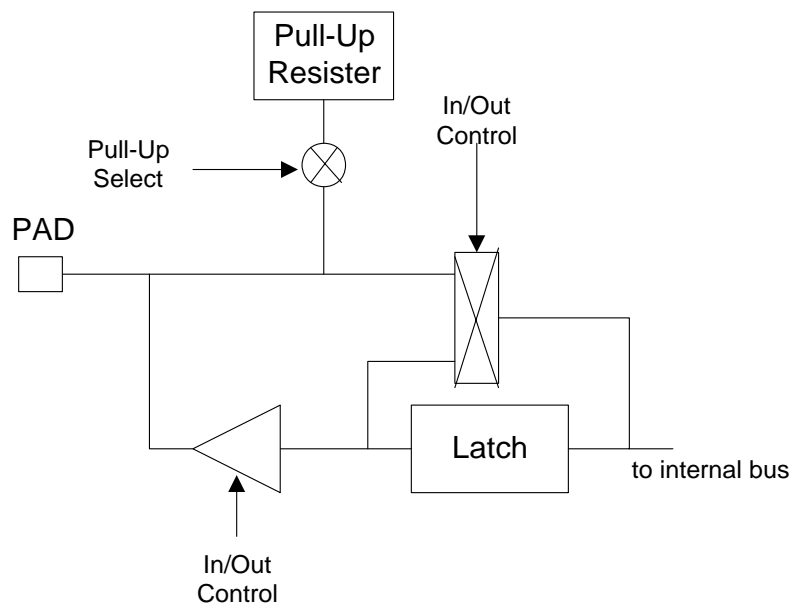


7. I/O PORT

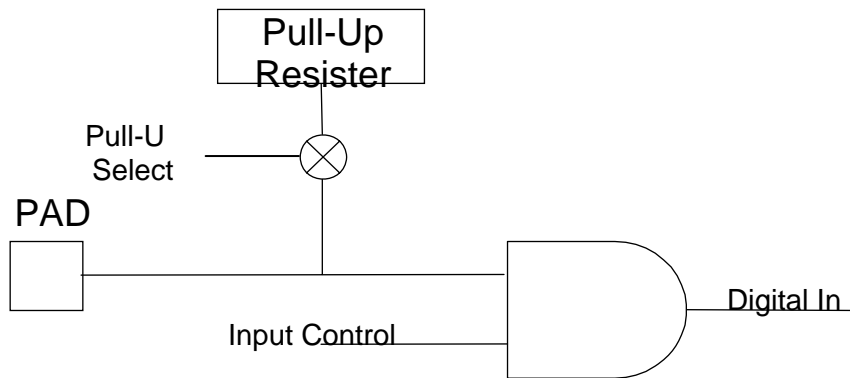
SNC749 provides one a 24-bit I/O port for user application (P0.0~P0.15, P1.0~P1.7). The input pull high resistor of each pin can be programmed by Port Pull-High register. The direction of I/O port is selected by Port Direction register.

The Port0 (P0.0~P0.15) and Port1 (P1.0~P1.7) can wake the chip up from the stop mode and watch mode. P0.15 can be modulated with a 38.5Khz carry signal to realize IR signal transmission.

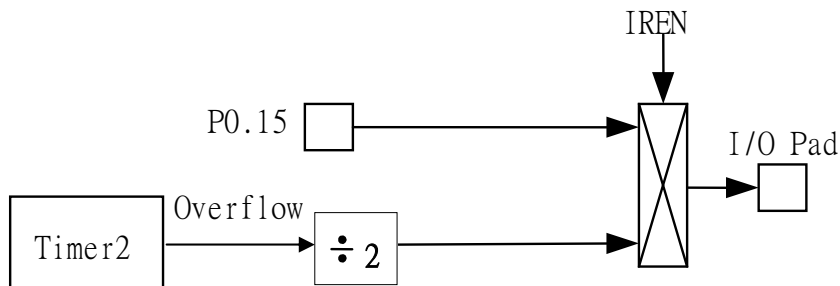
When user uses GPIO to wake up chip, the GPIO must setting to input mode and Pull-High all I/O pin.



I/O Configuration of P0.0~P0.15



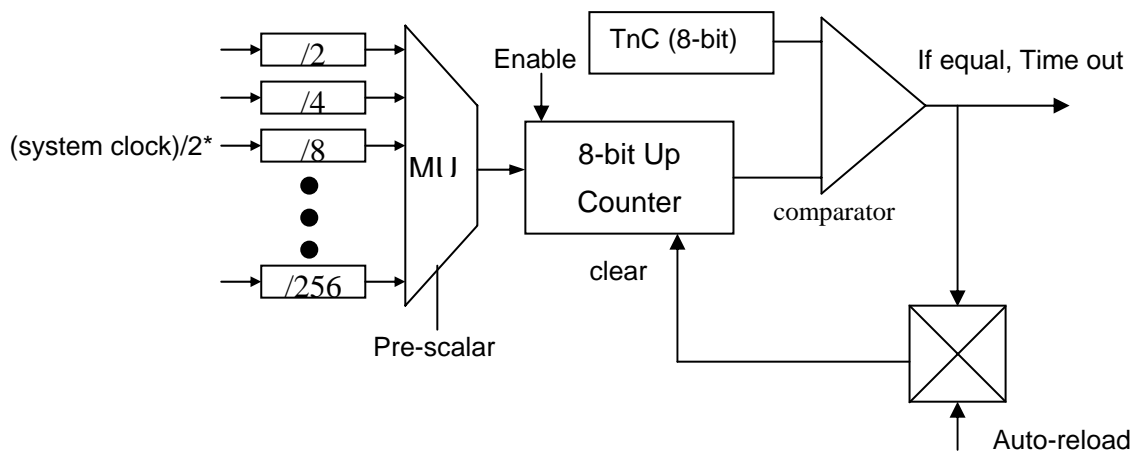
Input Port Configuration of Port 1 (P1.0~P1.7)



P0.15 Modulated with a carry signal

8. TIMER/COUNTER

SNC749 provides three 8-bit timer/event counters (T0/T1/T2). Each timer is 8-bit binary up-count timer with pre-scalar and auto-reload function. Timer 0 (T0) is used when voice playing, so user should avoid to use T0.



9. Push-Pull DAC

To play out voices, SNC749 only contains Push-Pull DAC (direct drive) for user to output voice.

10. Regulator

The SNC749 provide a linear regulator for core power (CVDD). The accuracy output voltage is $2.8V \pm 0.2V$ and it can be power-downed by software.

Features:

Input supply voltage: 3.6V ~ 5.1V

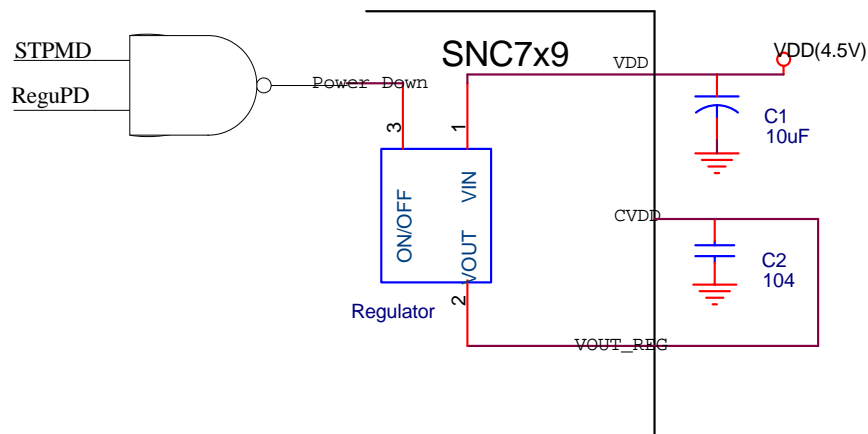
Dropout voltage of 0.8V at 20mA output current:

Output current: 20mA

Power down current: <1uA

Accuracy output voltage: 2.6~2.8V

Application circuit:



11. ABSOLUTE MAXIMUM RATINGS

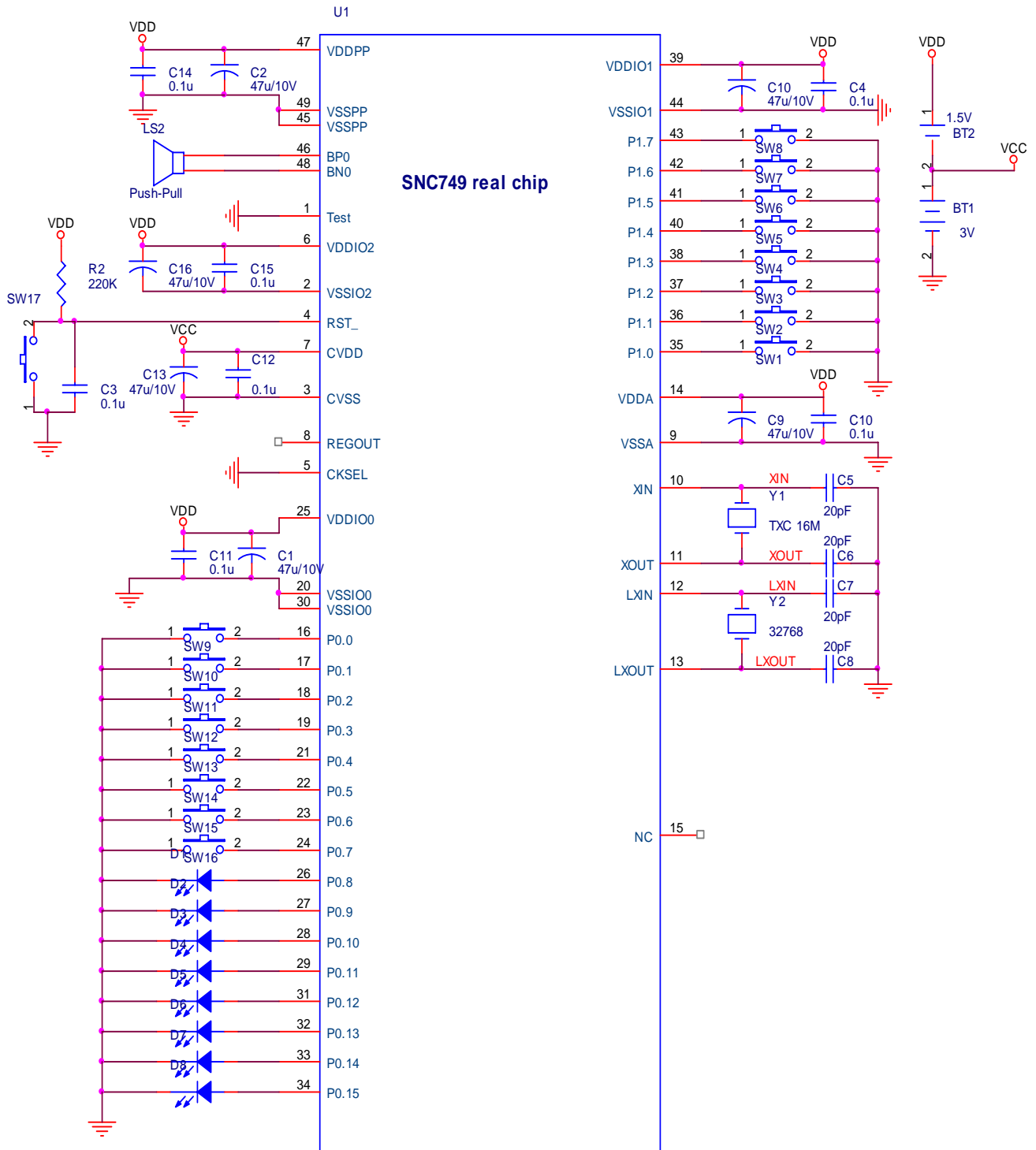
Items	Symbol	Min	Max	Unit.
Supply Voltage	V_{DD-V}	-0.3	6.0	V
Input Voltage	V_{IN}	GND-0.3	$V_{DD}+0.3$	V
Operating Temperature	T_{OP}	0	55	°C
Storage Temperature	T_{STG}	-55.0	125.0	°C

12. ELECTRICAL CHARACTERISTICS

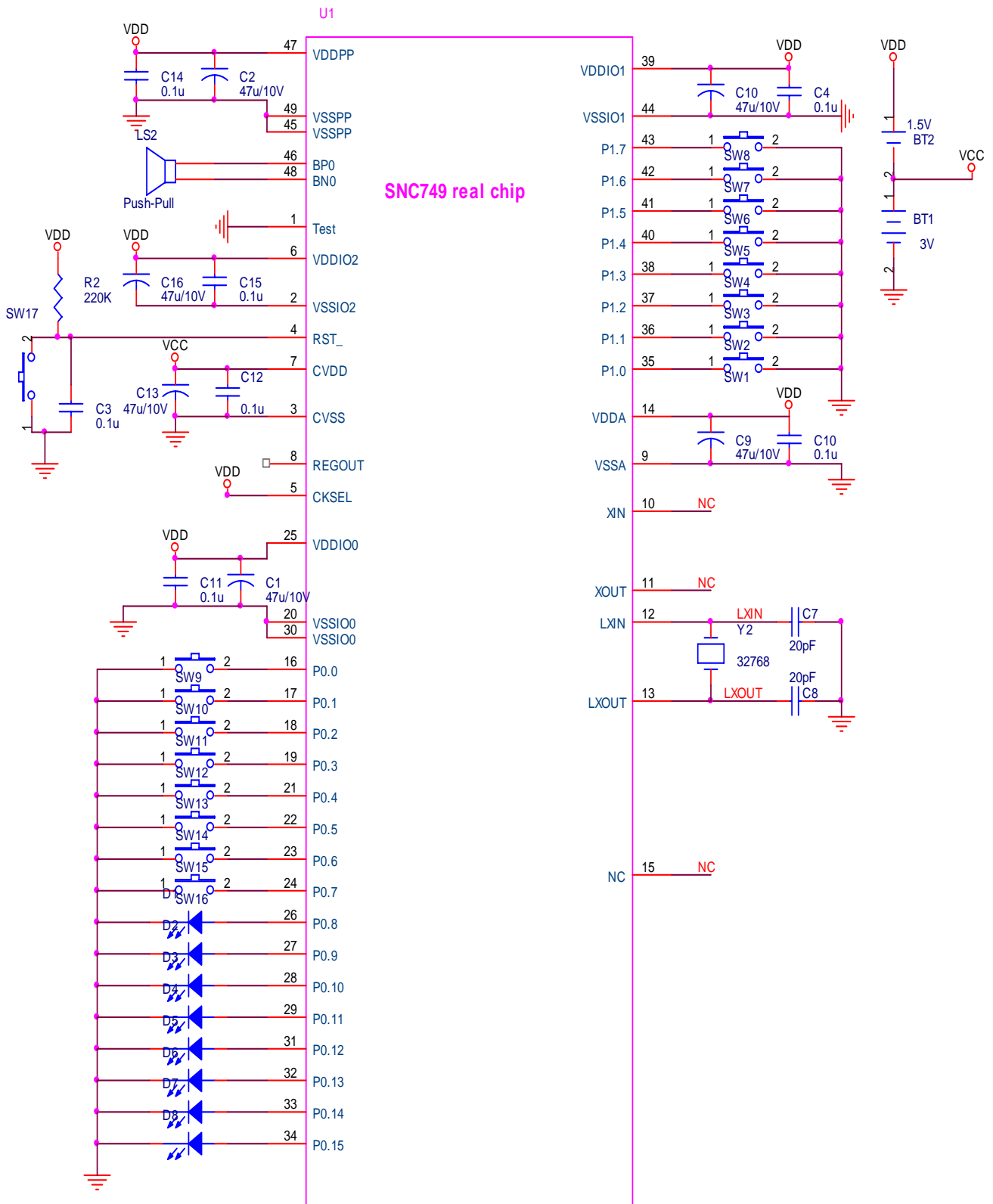
Item	Sym.	Min.	Typ.	Max.	Unit	Condition
Operating Voltage	V_{DD}	2.4	-	3.6	V	
	V_{DD}	3.6	-	5.1	V	
Standby current	I_{SBY}	-	2.0	-	μA	$V_{DD}=3V$, no load
Operating Current	I_{OPR}	-	10	-	mA	$V_{DD}=3V$, no load
Watch mode Current	I_{WCH}	-	12	-	μA	$V_{DD}=3V$, 9instructions
Slow mode Current	I_{SL}	-	250	-	μA	$V_{DD}=3.3V$, no load
Pull-Up resistor of P0, P1	R_{PU}	-	800	-	$K\Omega$	$V_{DD}=3V$, no load
Input current of P0, P1	I_{IH}	-	-	10.0	μA	$V_{DD}=3V, V_{IN}=3V$
Drive current of P0, P1	I_{OD}	-	4	-	mA	$V_{DD}=3V, V_O=2.4V$
Sink Current of P0, P1	I_{OS}	-	6	-	mA	$V_{DD}=3V, V_O=0.4V$
Drive current of Buo1	I_{OD}		150	-	mA	$V_{DD}=3V, Buo1=1.5V$
Sink Current of Buo1	I_{OS}		150	-	mA	$V_{DD}=3V, Buo1=1.5V$
Drive Current of Buo2	I_{OD}		150	-	mA	$V_{DD}=3V, Buo2=1.5V$
Sink Current of Buo2	I_{OS}		150	-	mA	$V_{DD}=3V, Buo2=1.5V$
Oscillation Freq. (crystal)	F_{OSC}	-	16.0	-	MHz	$V_{DD}=3V$

13. Application Circuit

X'TAL



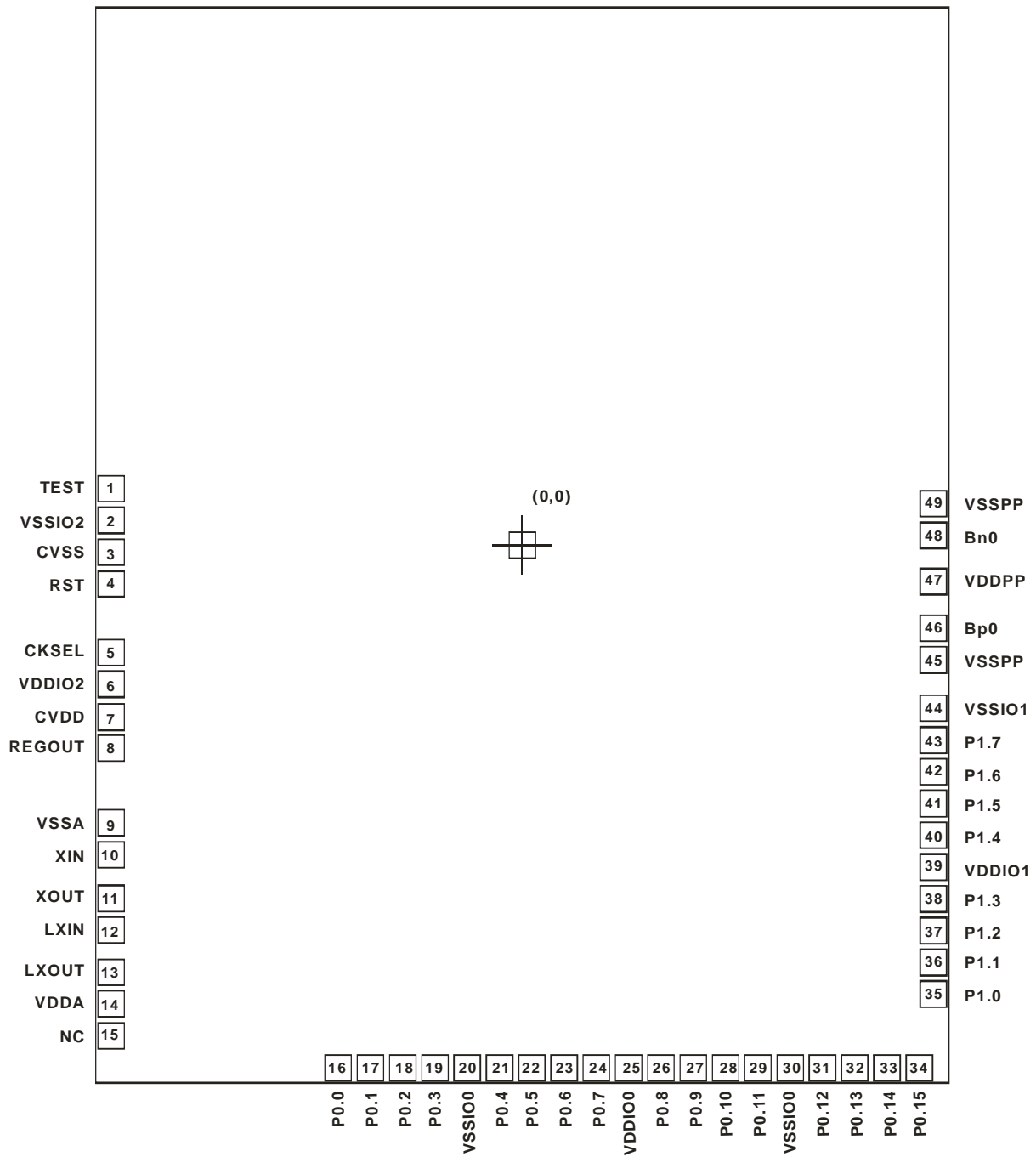
ROSC



Note: The SNC749 total have 6 powers, each power use one 47uF and one 0.1uF capacitor. If user wants to save cost, you can use 0.1uF on each power and add 47uF on VDDPP and VDDA.



14. Bonding PAD





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